

Vishay Semiconductors

# Phase Control Thyristor RMS SCRs, 25 A, 35 A



TO-48 (TO-208AA)

PRIMARY CHARACTERISTICS					
I <sub>T(AV)</sub>	16 A, 22 A				
I <sub>T(RMS)</sub>	25 A, 35 A				
V <sub>DRM</sub> /V <sub>RRM</sub>	25 V, 50 V, 100 V, 150 V, 200 V, 250 V, 300 V, 400 V, 500 V, 600 V, 700 V, 800 V, 1000 V 1200 V				
$V_{TM}$	2.3 V				
I <sub>GT</sub>	60 mA				
T <sub>J</sub>	-40 °C to +125 °C				
Package	TO-48 (TO-208AA)				
Circuit configuration	Single SCR				

### **FEATURES**

- · General purpose stud mounted
- Broad forward and reverse voltage range through 1200 V



 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES 2N681-92	VALUES 2N5205-07	UNITS		
1		16 <sup>(1)</sup>	22 <sup>(1)</sup>	A		
$I_{T(AV)}$	T <sub>C</sub>	-65 to +65 <sup>(1)</sup>	-40 to +40	°C		
I <sub>T(RMS)</sub>		25	35	A		
1	50 Hz	145	285	A		
I <sub>TSM</sub>	60 Hz	150 <sup>(1)</sup>	300 (1)	A		
l <sup>2</sup> t	50 Hz	103	410	A <sup>2</sup> s		
	60 Hz	94	375	A-s		
I <sub>GT</sub>		40	40	mA		
dV/dt		=	100 (1)	V/µs		
dl/dt		75 to 100	100	A/µs		
$V_{DRM}$	Range	25 to 800	600 to 1200	V		
$V_{RRM}$	Range	25 to 800	600 to 1200	V		
TJ		-65 to +125 <sup>(1)</sup>	-40 to +125 <sup>(1)</sup>	°C		

### Note

(1) JEDEC® registered value



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### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RATINGS (APPLIED GATE VOLTAGE ZERO OR NEGATIVE)						
TYPE NUMBER	V <sub>RRM</sub> /V <sub>DRM</sub> , MAXIMUM REPETITIVE PEAK REVERSE AND OFF-STATE VOLTAGE V	$V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE ( $t_p < 5 \text{ ms}$ )	TJ			
VS-2N681	25	35				
VS-2N682	50	75				
VS-2N683	100	150				
VS-2N684	150	200				
VS-2N685	200	300				
VS-2N686	250	350	05 00 + 105 00			
VS-2N687	300	400	-65 °C to +125 °C			
VS-2N688	400	500				
VS-2N689	500	600				
VS-2N690	600	720				
VS-2N691	700	840				
VS-2N692	800	960				
VS-2N5205	800	960				
VS-2N5206	1000	1200	-40 °C to +125 °C			
VS-2N5207	1200	1440				

#### Note

• JEDEC registered values

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CON	IDITIONS	VALUES 2N681-92	VALUES 2N5205-07	UNITS		
Maximum average on-state	I-(a) 0	180° half sine wave condu	ction	16 <sup>(1)</sup>	22 <sup>(1)</sup>	Α		
current at case temperature	I <sub>T(AV)</sub>	100 Hall Sille wave collud	Ction	-65 to +65 <sup>(1)</sup>	-40 to +40 <sup>(1)</sup>	°C		
Maximum RMS on-state current	I <sub>T(RMS)</sub>			25	35	Α		
		50 Hz half cycle sine wave or 6 ms rectangular pulse	Following any rated load condition, and with rated V <sub>RRM</sub> applied following surge  Same conditions as above except with V <sub>RRM</sub> applied following surge = 0	145	285	•		
Maximum peak, one-cycle	I <sub>TSM</sub>	60 Hz half cycle sine wave or 5 ms rectangular pulse		150 <sup>(1)</sup>	300 (1)			
non-repetitive surge current		50 Hz half cycle sine wave or 6 ms rectangular pulse		170	340	Α		
		60 Hz half cycle sine wave or 5 ms rectangular pulse		180	355			
		t = 10 ms	Rated V <sub>RRM</sub> applied	103	410			
Maximum I <sup>2</sup> t capability for fusing	I <sup>2</sup> t	t = 8.3 ms	following surge, initial T <sub>J</sub> = 125 °C V <sub>RRM</sub> = 0 following	94	375	A <sup>2</sup> s		
Maximum I <sup>2</sup> t capability for		t = 10 ms		145	580			
individual device fusing		t = 8.3 ms	surge, initial $T_J = 125  ^{\circ}\text{C}$	135	530			
Maximum I <sup>2</sup> √t capability for individual device fusing	I <sup>2</sup> √t <sup>(2)</sup>	$t = 0.1$ ms to 10 ms, initial $V_{RRM}$ applied following sur	1450	5800	A²√s			
Maximum peak on-state voltage	V <sub>TM</sub>	$T_J = 25$ °C, $I_{T(AV)} = 16$ A (50 $I_{T(AV)} = 22$ A (70 A peak) 2N	2 (1)	2.3 (1)	V			
Maximum holding current	I <sub>H</sub>	Anode supply 24 V, initial I	<sub>T</sub> = 1.0 A	20 at 25 °C (typical)	200 <sup>(1)</sup> at -40 °C	mA		

### Notes

<sup>(1)</sup> JEDEC registered value

<sup>(2)</sup>  $I^2t$  for time  $t_x = I^2 \sqrt{t} \cdot \sqrt{t_x}$ 



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SWITCHING							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES 2N681-92	VALUES 2N5205-07	UNITS	
	V <sub>DM</sub> = 25 V to 600 V		$T_C = 125  ^{\circ}C$ , $V_{DM} = Rated  V_{DRM}$ ,	100	ı		
Maximum non-repetitive rate of rise of turned-on current	V <sub>DM</sub> = 700 V to 800 V	dI/dt ·	$I_{TM}$ = 2 x dI/dt, gate pulse = 20 V, 15 $\Omega$ , $t_p$ = 6 $\mu$ s, $t_r$ = 0.1 $\mu$ s maximum Per JEDEC standard RS-397, 5.2.2.6	75	-	A/µs	
			$T_C$ = 125 °C, $V_{DM}$ = 600 V, $I_{TM}$ = 200 A at 400 Hz maximum, gate pulse = 20 V, 15 $\Omega$ , $t_p$ = 6 $\mu$ s, $t_r$ = 0.1 $\mu$ s maximum Per JEDEC standard RS-397, 5.2.2.6	-	100	7 ν μσ	
Typical delay time		t <sub>d</sub>	$T_C$ = 25 °C, $V_{DM}$ = Rated $V_{DRM}$ , $I_{TM}$ = 10 A DC resistive circuit, gate pulse = 10 V, 40 $\Omega$ source, $t_p$ = 6 $\mu$ s, $t_r$ = 0.1 $\mu$ s	1	1	μs	

BLOCKING							
PARAMETER		SYMBOL	TEST CONDITIONS		VALUES 2N681-92	VALUES 2N5205-07	UNITS
Minimum critical rate of rise of off-state voltage		dV/dt	$T_J = 125$ °C, exponential to 100 % rated $V_{DRM}$	Gate open	100 (typical)	100 (1)	\//a
			$T_J = 125$ °C, exponential to 67 % rated $V_{DRM}$	circuited	250 (typical)	250	· V/μs
	$V_{RRM}$ , $V_{DRM} = 400 \text{ V}$				3.5	-	
	$V_{RRM}$ , $V_{DRM} = 500 V$		T <sub>J</sub> = 125 °C		3.5	-	
Marrian un	$V_{RRM}$ , $V_{DRM} = 600 V$				2.5	3.3	
Maximum reverse leakage current	$V_{RRM}$ , $V_{DRM} = 700 V$	I <sub>DRM</sub> ,			2.2	-	mA
-	$V_{RRM}$ , $V_{DRM} = 800 V$	I <sub>RRM</sub>			2	2.5	
	V <sub>RRM</sub> , V <sub>DRM</sub> = 1000 V				-	2	1
	V <sub>RRM</sub> , V <sub>DRM</sub> = 1200 V				-	1.7	

### Note

(1) JEDEC registered value

TRIGGERING						
PARAMETER	SYMBOL		TEST CONDITIONS		VALUES 2N5205-07	UNITS
Maximum peak gate power	P <sub>GM</sub>		2N681 series; or 2N5204 series	5 (1)	60 <sup>(1)</sup>	W
Maximum average gate power	P <sub>G(AV)</sub>			0.5 (1)	0.5 (1)	
Maximum peak positive gate current	+I <sub>GM</sub>			2 (1)	2	Α
Maximum peak positive gate voltage	+V <sub>GM</sub>			10 <sup>(1)</sup>	-	V
Maximum peak negative gate voltage	-V <sub>GM</sub>			5 <sup>(1)</sup>	5 <sup>(1)</sup>	V
Maximum required DC gate current to trigger	I <sub>GT</sub>	T <sub>C</sub> = min. rated value	Maximum required gate trigger current is the lowest value which will trigger all units with + 6 V anode to cathode	80 (1)	80 (1)	
		T <sub>C</sub> = 25 °C		40	40	mA
		T <sub>C</sub> = 125 °C		18.5	20	
Typical DC gate current to trigger		$T_C = 25  ^{\circ}C, +$	6 V anode to cathode	30	30	
Maximum required DC gate voltage to trigger	V <sub>GT</sub>	T <sub>C</sub> = -65 °C	Maximum required gate trigger voltage is the lowest value which will trigger all units with + 6 V anode to cathode	3 (1)	3 (1)	V
		T <sub>C</sub> = 25 °C		2	2	
Typical DC gate voltage to trigger		T <sub>C</sub> = 25 °C, + 6 V anode to cathode		1.5	1.5	
Maximum DC gate voltage not to trigger	$V_{GD}$	T <sub>C</sub> = 125 °C	Maximum gate voltage not to trigger is the maximum value which will not trigger any unit with rated V <sub>DRM</sub> anode to cathode	0.25 (1)	0.25 (1)	V

#### Note

(1) JEDEC registered value



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THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES 2N681-92	VALUES 2N5205-07	UNITS	
Operating junction and storage temperature rar	nge	T <sub>J</sub> , T <sub>Stg</sub>		-65 to 125 <sup>(1)</sup>	-40 to 125 <sup>(1)</sup>	°C	
Maximum internal thermal resistance, junction to case		R <sub>thJC</sub>	DC operation 1.		1.5 <sup>(1)</sup>	°C/W	
Typical thermal resistance, case to sink		R <sub>thCS</sub>	Mounting surface, smooth, flat and greased	0.35	0.35	C/VV	
			Lukii atad thusada	20 (27.5)		lbf ⋅ in	
	to nut		Lubricated threads (Non-lubricated threads)	0.23 (0.32)		kgf · cm	
Mounting torque		(Non-lubricated tilleads)		2.3 (3.1)		N·m	
± 10 %				25		lbf ⋅ in	
to device		Lubricated threads		0.29		kgf · cm	
				2.8		N·m	
Approximate weight	Approximate weight			14	14	g	
Approximate weight				0.49	0.5	OZ.	
Case style				TO-48 (TO-208AA)		·	

#### Note

<sup>(1)</sup> JEDEC registered value

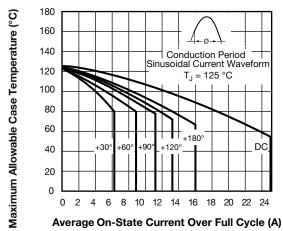


Fig. 1 - Maximum Allowable Case Temperature vs. Average On-State Current, 2N681 Series

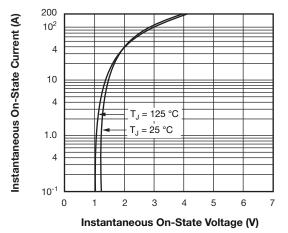
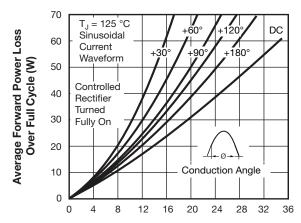


Fig. 2 - Maximum On-State Voltage vs. Current, 2N681 Series



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### Average On-State Current Over Full Cycle (A)

Fig. 3 - Maximum Low Level On-State Power Loss vs. Current (Sinusoidal Current Waveform), 2N681 Series

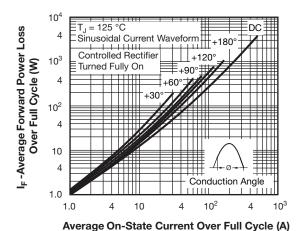
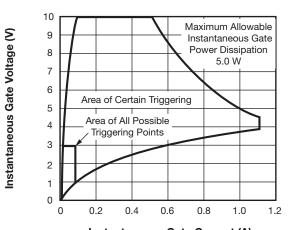


Fig. 4 - Maximum High Level On-State Power Loss vs. Current (Sinusoidal Current Waveform), 2N681 Series



Instantaneous Gate Current (A)
Fig. 5 - Gate Characteristics,
2N681 Series

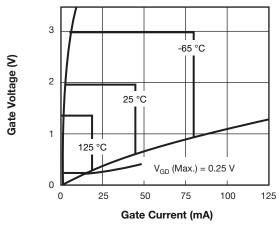


Fig. 5a - Area of All Possible Triggering Points vs. Temperature, 2N681 Series

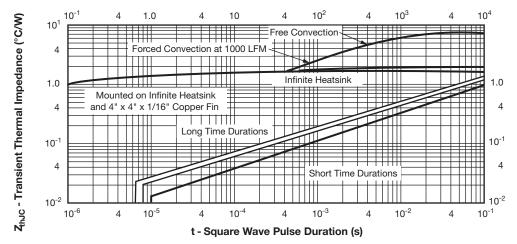


Fig. 6 - Maximum Transient Thermal Impedance, Junction to Case, vs. Pulse Duration, 2N681 Series

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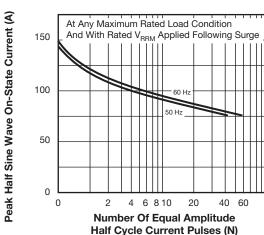


Fig. 7 - Maximum Non-Repetitive Surge Current vs. Number of Current Pulses, 2N681 Series

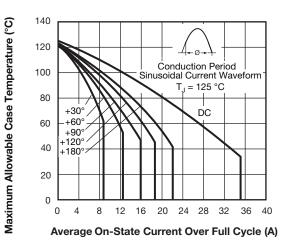


Fig. 8 - Maximum Allowable Case Temperature vs. Average On-State Current (Sinusoidal Current Waveform), 2N5205 Series

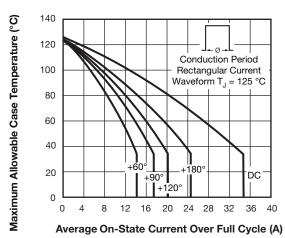
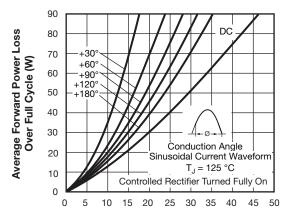


Fig. 9 - Maximum Allowable Case Temperature vs. Average On-State Current (Rectangular Current Waveform), 2N5205 Series



Average On-State Current Over Full Cycle (A)

Fig. 10 - Maximum Low-Level On-State Power Loss vs. Average On-State Current (Sinusoidal Current Waveform), 2N5205 Series

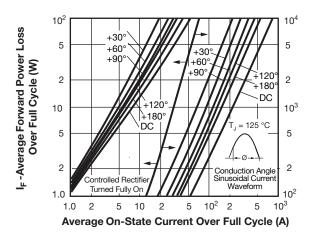
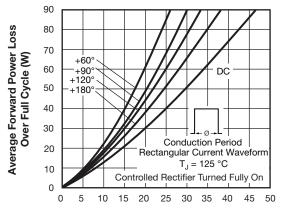


Fig. 11 - Maximum High-Level On-State Power Loss vs. Average On-State Current (Sinusoidal Current Waveform), 2N5205 Series



Average On-State Current Over Full Cycle (A)

Fig. 12 - Maximum Low-Level On-State Power Loss vs. Average On-State Current (Rectangular Current Waveform), 2N5205 Series



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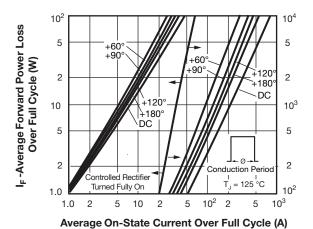


Fig. 13 - Maximum High-Level On-State Power Loss vs. Average On-State Current (Rectangular Current Waveform), 2N5205 Series

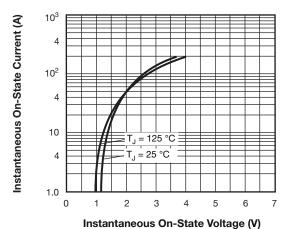


Fig. 14 - Maximum Instantaneous On-State Voltage vs. Instantaneous On-State Current, 2N5205 Series

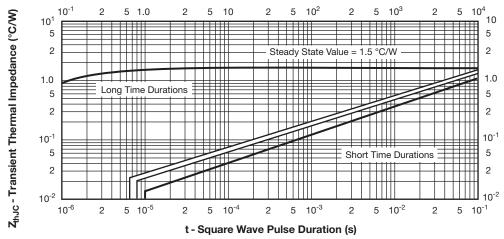


Fig. 15 - Maximum Transient Thermal Resistance, Junction to Case vs. Pulse Duration, 2N5205 Series

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishav.com/doc?95333			

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